

## **Application Data Sheet**

### **Application Information**

|                                  |                               |
|----------------------------------|-------------------------------|
| Application Type::               | Regular                       |
| Subject Matter::                 | Utility                       |
| Suggested Classification::       |                               |
| Suggested Group Art Unit::       |                               |
| CD-ROM or CD-R?::                | None                          |
| Number of CD Disks::             |                               |
| Number of Copies of CDs::        |                               |
| Sequence Submission?::           |                               |
| Computer Readable Form (CRF)?::  |                               |
| Number of copies of CRF::        |                               |
| Title::                          | HEAT RADIATING DEVICE OF CHIP |
| Attorney Docket Number::         | LIN 201                       |
| Request for Early Publication?:: | No                            |
| Request for Non-Publication?::   | No                            |
| Suggested Drawing Figure::       |                               |
| Total Drawing Sheets::           | 13                            |
| Small Entity?::                  | Yes                           |
| Latin Name::                     |                               |
| Variety Denomination Name::      |                               |
| Petition Included::              | No                            |
| Petition Type::                  |                               |
| Licensed US Govt. Agency::       |                               |
| Contract or Grant Numbers::      |                               |
| Secrecy Order in Parent Appl.?:: | No                            |

### **Applicant Information**

|                               |               |
|-------------------------------|---------------|
| Applicant Authority Type::    | Inventor      |
| Primary Citizenship Country:: | Taiwan        |
| Status::                      | Full Capacity |
| Given Name::                  | Ming-Chen     |
| Middle Name::                 |               |

Family Name:: LIN  
Name Suffix::  
City of Residence:: Keelung City,  
State or Province of Residence::  
Country of Residence:: Taiwan R.O.C.  
Street of Mailing Address:: 3F, No. 115, Hsin I Rd., Lin 13, Jen Shou  
Li, Hsin 1 Dist.  
City of Mailing Address:: Keelung City  
State or Province of Mailing Address::  
Country of Mailing Address:: Taiwan, R.O.C.  
Postal or Zip Code of Mailing Address::  
Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Taiwan, R.O.C.  
Status:: Full Capacity  
Given Name:: Tzung-Lung  
Middle Name::  
Family Name:: LEE  
Name Suffix::  
City of Residence:: Taipei Hsien  
State or Province of Residence::  
Country of Residence:: Taiwan, R.O.C.  
Street of Mailing Address:: 2F, No. 19-6, Alley 1, Lane 176, Fu-The 1<sup>st</sup>  
Rd., Shi-Chi City.  
City of Mailing Address:: Taipei Hsien  
State or Province of Mailing Address::  
Country of Mailing Address:: Taiwan, R.O.C.  
Postal or Zip Code of Mailing Address::  
**Correspondence Information**  
Correspondence Customer Number:: 001444  
**Representative Information**  
Representative Customer Number:: 001444  
**Domestic Priority Information**  
Application:: Continuity Type:: Parent Application:: Parent Filing

Date::

**Foreign Priority Information**

Country::                      Application Number::      Filing Date::      Priority Claimed::

**Assignment Information**

|   |  |
|---|--|
| Assignee Name::                         | Advanced Thermal Technologies  |
| Street of Mailing Address::             | 2F, No. 19-6, Alley 1, Lane 176, Fu-The 1 <sup>st</sup><br>Rd., Shi-Chi City |
| City of Mailing Address::               | Taipei Hsien   |
| State or Province of Mailing Address::  |  |
| Country of Mailing Address::            | Taiwan, R.O.C.   |
| Postal or Zip Code of Mailing Address:: |  |